

## **Customer Information Notification**

2023020071: TJA1042 Datasheet Update

**Note:** This notice is NXP Company Proprietary.

Issue Date: Feb 17, 2023 Effective date:Mar 17, 2023

Here is your personalized notification about a NXP general announcement. For detailed information we invite you to view this notification online

## Management summary TJA1042 datasheet update

## **Change Category**

[]Wafer Fab Process	[]Assembly Process	[]Product Marking	[]Test Process	[]Design
[]Wafer Fab Materials	[]Assembly Materials	[]Mechanical Specification	[]Test Equipment	[]Errata
[]Wafer Fab Location	[]Assembly Location	[]Packing/Shipping/Labeling	[]Test Location	[]Electrical spec./Test coverage

[]Firmware [X]Other: Datasheet update

# **PCN Overview**

# **Description**

NXP Product Line In-Vehicle Networking (PL IVN) is updating the datasheet of product TJA1042. Two new product versions (TJA1042BT and TJA1042CT) have been added to the datasheet, and textual and figure updates have been made. No physical or design change has been made to the product.

The datasheet's revision history specifies the updates.

Attached to this Customer Information Notification (CIN) are three additional documents:

- A pdf document with detailed info on the datasheet update
- The applicable ZVEI Delta Qualification Matrix (DeQuMa) for this datasheet updates, both in zipped excel and pdf format. The applicable change ID numbers are SEM-DS-02 and SEM-DS-03
- The new TJA1042 datasheet, which will also be published on the NXP website (www.nxp.com) one month after the distribution of this CIN to customers

See the paragraphs 'Additional information' and 'Remarks' below for instructions on how to obtain these documents.

For the newly released TJA1042BT and TJA1042CT products a PPAP is available on request. **Reason** 

NXP PL IVN wants to properly inform you of the improved datasheet specifications for the TJA1042 product family.

#### **Identification of Affected Products**

Product identification does not change

## Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality

**Data Sheet Revision** 

A new datasheet will be issued

### Additional information

Additional documents: view online

#### Remarks

Please use the link 'view online' under the heading 'Additional information' above, to log in to the NXP e-PCN system you're subscribed to, in order to obtain the attached document with relevant detailed information from the tab 'Files'.

Should you not be able to obtain this document, please contact your NXP sales representative or the e-mail address mentioned below under 'Contact and Support'.

## **Contact and Support**

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Kees van Hasselt

Position Quality Account Manager

e-mail

address ivn.customer.service@nxp.com

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NXP Quality Management Team.

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Changed Orderable Part#	12NC Proc	duct Type	<b>Product Description</b>	Package Outline	Package Description	Product Status	<b>Customer Specific Indicator</b>	<b>Product Line</b>
TJA1042T,112	935285277112 TJA1	1042T	HS-CAN TRANSCEIVER	SO8	SOT96-1	DOD	No	BLC1
TJA1042T,118	935285277118 TJA1	1042T	HS-CAN TRANSCEIVER	SO8	SOT96-1	RFS	No	BLC1
TJA1042T/1U	935302719112 TJA1	1042T/1	HS-CAN TRANSCEIVER	SO8	SOT96-1	DOD	No	BLC1
TJA1042T/1J	935302719118 TJA1	1042T/1	HS-CAN TRANSCEIVER	SO8	SOT96-1	RFS	No	BLC1
TJA1042T/3,112	935285279112 TJA1	1042T/3	HS-CAN TRANSCEIVER	SO8	SOT96-1	DOD	No	BLC1
TJA1042T/3,118	935285279118 TJA1	1042T/3	HS-CAN TRANSCEIVER	SO8	SOT96-1	RFS	No	BLC1
TJA1042T/3/1U	935302721112 TJA1	1042T/3/1	HS-CAN TRANSCEIVER	SO8	SOT96-1	DOD	No	BLC1
TJA1042T/3/1J	935302721118 TJA1	1042T/3/1	HS-CAN TRANSCEIVER	SO8	SOT96-1	RFS	No	BLC1
TJA1042T/3/CM,118	935295727118 TJA1	1042T/3/CM	HS-CAN TRANSCEIVER	SO8	SOT96-1	RFS	No	BLC1
TJA1042T/CM,118	935295726118 TJA1	1042T/CM	HS-CAN TRANSCEIVER	SO8	SOT96-1	RFS	No	BLC1
TJA1042TK/3,118	935285293118 TJA1	1042TK/3	HS-CAN TRANSCEIVER	H(V)SON8WF	SOT782-1	RFS	No	BLC1
TJA1042TK/3/1J	935302716118 TJA1	1042TK/3/1	HS-CAN TRANSCEIVER	H(V)SON8WF	SOT782-1	RFS	No	BLC1
TJA1042U,027	935288947027 TJA1	1042U	HS-CAN TRANSCEIVER			RFS	No	BLC1
TJA1042U,029	935288947029 TJA1	.1042U	HS-CAN TRANSCEIVER			RFS	No	BLC1